



N-Channel Reduced Q_g , Fast Switching MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A)	Q _g (Typ.)		
30	0.007 at V _{GS} = 10 V	16	11		
	0.0095 at V _{GS} = 4.5 V	13.5			

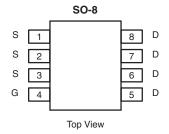
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Gen II Power MOSFETs
- · PWM Optimized
- 100 % R_g Tested

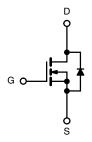


APPLICATIONS

• DC/DC Conversion for PC



Ordering Information: Si4386DY-T1-E3 (Lead (Pb)-free) Si4386DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS TA	$_{\lambda}$ = 25 °C, unle	ss otherwise r	noted		
Parameter	Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	I _D	16	11	
Continuous Dialit Current (1) = 150 C)	T _A = 70 °C		13	9	
Pulsed Drain Current		I _{DM}	± 50		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.8	1.3	
Single Pulse Avalanche Current	igle Pulse Avalanche Current L = 0.1 mH		20		
Avalanche Energy	L = 0.111111	E _{AS}		20	mJ
Manianum Danian Disaination	T _A = 25 °C	P _D	3.1	1.47	W
Maximum Power Dissipation ^a	T _A = 70 °C] ''	2	0.95	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 5	5 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manipular Landing to Applicat (MOOFFT)	t ≤ 10 s	R _{thJA}	34	40	
Maximum Junction-to-Ambient (MOSFET) ^a	Steady State	' 'thJA	71	85	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	18	22	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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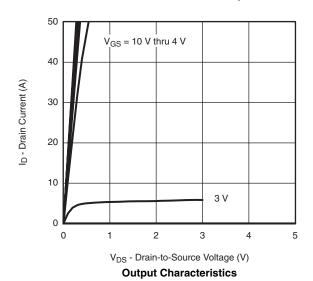
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5	2.0	2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Cata Valtana Duain Comunant		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	_{DS} = 30 V, V _{GS} = 0 V, T _J = 70 °C		10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
	В	$V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$		0.0058	0.007	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 13.5 A		0.0078	0.0095	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 16 \text{ A}$		51		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic ^b	<u>l</u>				<u> </u>		
Total Gate Charge	Q_g			11	18		
Gate-Source Charge	Q_{gs} $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V},$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 16 \text{ A}$		5.8		nC	
Gate-Drain Charge	Q_{gd}			3.0			
Gate Resistance	R_g		0.8	1.7	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			12	18		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		9	14		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 6 \Omega$		35	53	ns	
Fall Time	t _f			10	15		
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 2.8 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}$		25	50		

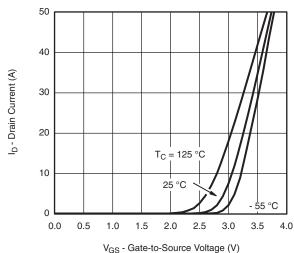
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



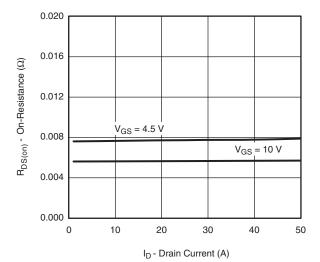




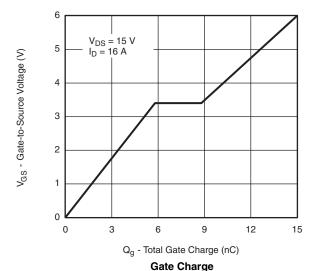




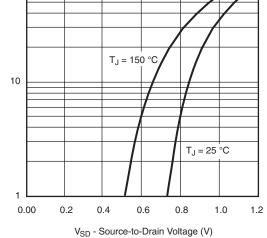
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current



T_J = 150 °C

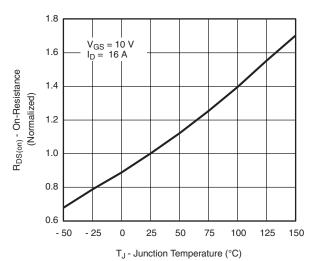


Source-Drain Diode Forward Voltage

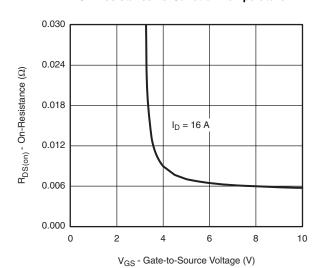
2200 Ciss 1760 C - Capacitance (pF) 1320 880 Coss 440 C_{rss} 0 0 4 8 12 16 20

V_{DS} - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

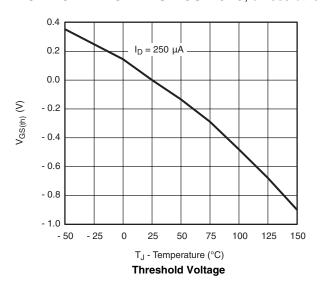
60

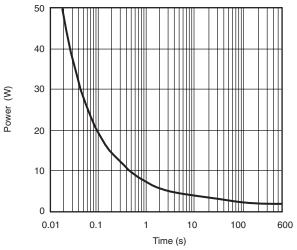
I_S - Source Current (A)

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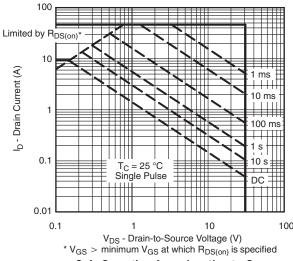
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

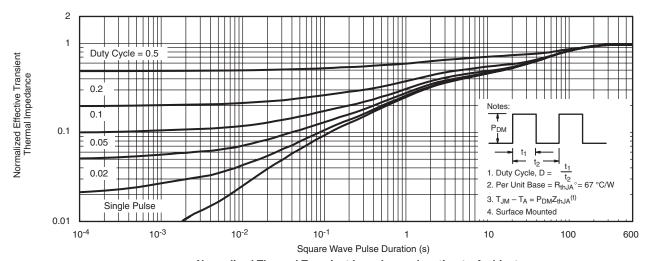




Single Pulse Power



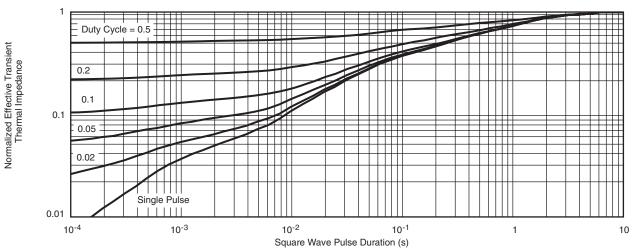
Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

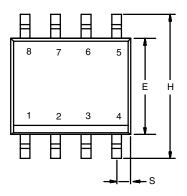


Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73109.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
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DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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